

# Zytel® HTN51G35HSLR BK420

## HIGH PERFORMANCE POLYAMIDE RESIN

Zytel® HTN high performance polyamide resins feature high retention of properties upon exposure to elevated temperature, to high moisture and to harsh chemical environments. Polymer families and grades of Zytel® HTN are tailored to optimize performance as well as processability.

Typical applications with Zytel® HTN include demanding applications in the automotive, electrical and electronics, domestic appliances, and construction industries.

Zytel® HTN51G35HSLR BK420 is a 35% glass reinforced, heat stabilised, lubricated, hydrolysis resistant high performance polyamide resin. It is also a PPA resin.

### Product information

Resin Identification	PA6T/XT-GF35	ISO 1043
Part Marking Code	>PA6T/XT-GF35<	ISO 11469
Part Marking Code	>PPA-GF35<	SAE J1344
ISO designation	ISO 16396-PA6T/XT,GF35,M1CGHRW,S10-120	

### Rheological properties

	dry/cond.	
Melt volume-flow rate	19/* cm³/10min	ISO 1133
Melt mass-flow rate	21/* g/10min	ISO 1133
Temperature	325/* °C	
Load	2.16/* kg	
Melt mass-flow rate, Temperature	325/* °C	
Melt mass-flow rate, Load	2.16/* kg	
Moulding shrinkage, parallel	0.2/- %	ISO 294-4, 2577
Moulding shrinkage, normal	0.6/- %	ISO 294-4, 2577

### Typical mechanical properties

	dry/cond.	
Tensile Modulus	12000/12000 MPa	ISO 527-1/-2
Stress at break, 5mm/min	200/190 MPa	ISO 527-1/-2
Strain at break, 5mm/min	2.3/2 %	ISO 527-1/-2
Flexural Modulus	10000/- MPa	ISO 178
Charpy impact strength, 23°C	50/40 kJ/m²	ISO 179/1eU
Charpy notched impact strength, 23°C	9/8 kJ/m²	ISO 179/1eA
Ball indentation hardness, H 961/30	310/- MPa	ISO 2039-1
Poisson's ratio	0.33/0.33	

### Thermal properties

	dry/cond.	
Melting temperature, first heat	300/* °C	ISO 11357-1/-3
Glass transition temperature, 10°C/min	140/95 °C	ISO 11357-1/-3
Temp. of deflection under load, 1.8 MPa	260/* °C	ISO 75-1/-2
Temp. of deflection under load, 0.45 MPa	280/* °C	ISO 75-1/-2
Coeff. of linear therm. expansion, parallel, -40-23°C	20/* E-6/K	ISO 11359-1/-2
Coeff. of linear therm. expansion, parallel	20/* E-6/K	ISO 11359-1/-2
Coeff. of linear therm. expansion, normal, -40-23°C	55/* E-6/K	ISO 11359-1/-2

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Coeff. of linear therm. expansion, normal	58 /*	E-6/K	ISO 11359-1/-2
Spec. heat capacity of melt	1820	J/(kg K)	Internal
Spec. heat capacity solid	610 <sup>[DS]</sup>	J/(kg K)	Internal
TGA curve	available		ISO 11359-1/-2

[DS]: Derived from similar grade

### Flammability

FMVSS Class	B	ISO 3795 (FMVSS 302)
Burning rate, Thickness 1 mm	28 mm/min	ISO 3795 (FMVSS 302)

### Electrical properties

Volume resistivity	1E13 /-	dry/cond.	Ohm.m	IEC 62631-3-1
Electric strength	34/33		kV/mm	IEC 60243-1

### Other properties

Humidity absorption, 2mm	1.4 /*	%	Sim. to ISO 62
Water absorption, 2mm	4 /*	%	Sim. to ISO 62
Density	1470 /-	kg/m <sup>3</sup>	ISO 1183

### VDA Properties

Odour	4 class	VDA 270
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### Injection

Drying Recommended	yes	
Drying Temperature	100 °C	
Drying Time, Dehumidified Dryer	6 - 8 h	
Processing Moisture Content	≤0.1 %	
Melt Temperature Optimum	325 °C	Internal
Min. melt temperature	320 °C	
Max. melt temperature	330 °C	
Mold Temperature Optimum	150 °C	
Min. mould temperature	140 <sup>[1]</sup> °C	
Max. mould temperature	180 °C	

[1]: Higher temperature needed for thinner sections.

### Characteristics

Additives	Release agent
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### Additional information

#### Injection molding

During molding, use proper protective equipment and adequate ventilation. Avoid exposure to fumes and limit the hold up time and temperature of the resin in the machine. Purge degraded resin carefully with HDPE.

When lower mold temperatures are used, the initial warpage and shrinkage may be lower, but the surface appearance and chemical resistance may be reduced, and the dimensional change may be greater when parts are subsequently heated.

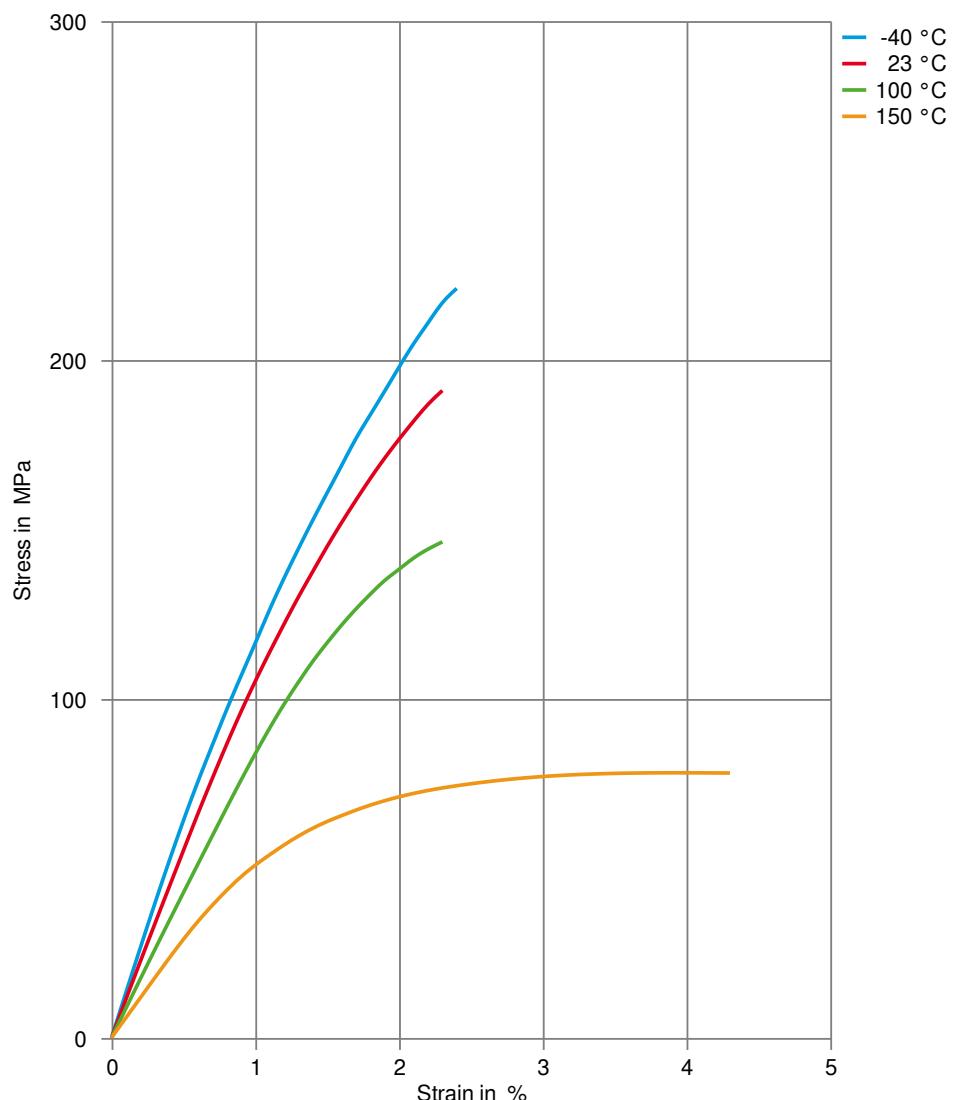
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## HIGH PERFORMANCE POLYAMIDE RESIN

### Stress-strain (dry)



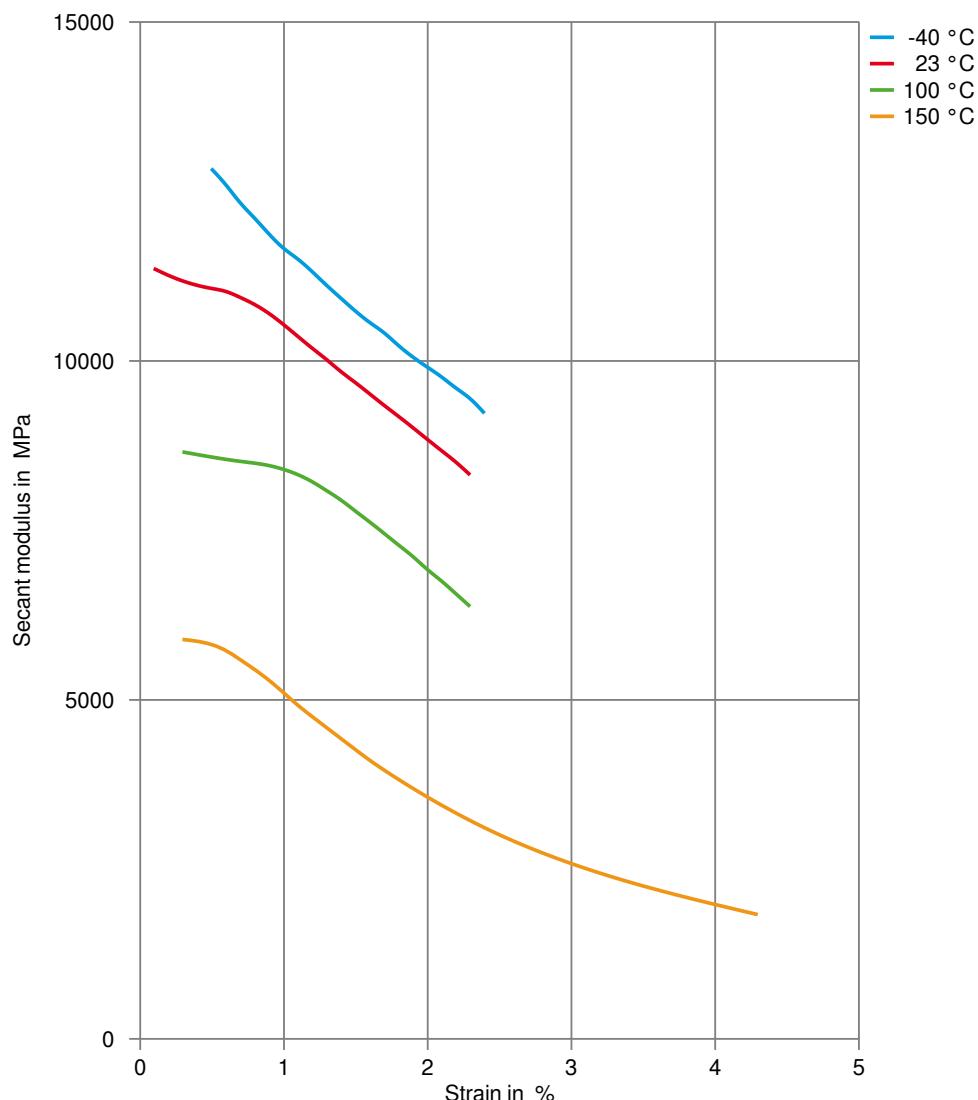
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## HIGH PERFORMANCE POLYAMIDE RESIN

Secant modulus-strain (dry)



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## HIGH PERFORMANCE POLYAMIDE RESIN

### Chemical Media Resistance

#### Acids

- ✓ Acetic Acid (5% by mass), 23°C
- ✓ Citric Acid solution (10% by mass), 23°C
- ✓ Lactic Acid (10% by mass), 23°C

#### Mineral oils

- ✓ SAE 10W40 multigrade motor oil, 23°C
- ✓ Insulating Oil, 23°C

#### Standard Fuels

- ✓ ISO 1817 Liquid 1 - E5, 60°C
- ✓ ISO 1817 Liquid 2 - M15E4, 60°C
- ✓ ISO 1817 Liquid 3 - M3E7, 60°C
- ✓ ISO 1817 Liquid 4 - M15, 60°C
- ✓ Standard fuel without alcohol (pref. ISO 1817 Liquid C), 23°C
- ✓ Standard fuel with alcohol (pref. ISO 1817 Liquid 4), 23°C
- ✓ Diesel fuel (pref. ISO 1817 Liquid F), 23°C
- ✓ Diesel fuel (pref. ISO 1817 Liquid F), 90°C
- ✓ Diesel fuel (pref. ISO 1817 Liquid F), >90°C
- ✓ Diesel EN 590, 100°C

#### Other

- ✓ Ethylene Glycol (50% by mass) in water, 108°C
- ✓ Water, 23°C
- ✓ Water, 90°C
- ✓ Coolant Glysantin G48, 1:1 in water, 125°C

#### Symbols used:

- ✓ possibly resistant

Defined as: Supplier has sufficient indication that contact with chemical can be potentially accepted under the intended use conditions and expected service life. Criteria for assessment have to be indicated (e.g. surface aspect, volume change, property change).

- ✗ not recommended - see explanation

Defined as: Not recommended for general use. However, short-term exposure under certain restricted conditions could be acceptable (e.g. fast cleaning with thorough rinsing, spills, wiping, vapor exposure).

